

Testing Performed Internally In Support of the Chemical Process Accreditation

- B04 – Microhardness Testing In Support of AC7108
- B05 – Salt Spray Testing In Support of AC7108
- B06 – Water Immersion / Humidity Testing In Support of AC7108
- B10 – Adhesion Testing (Adhesion Tape Testing) In Support of AC7108
- B11 – Adhesion Testing (Scratch and Chisel Test) In Support of AC7108
- B12 – Adhesion Testing (Bend Test) In Support of AC7108
- B14 – Conductivity Testing In Support of AC7108
- B16 – Coating Thickness Measurement In Support of AC7108
- B17 – Solderability Test In Support of AC7108
- B18 – Adhesion Testing (Heat & Quench) In Support of AC7108
- B20 – Porosity Testing In Support of AC7108
- B23 – Other Testing In Support of AC7108

**AC7108/9 - Nadcap Audit Criteria for Electroplating and Electroforming (to be used on audits on/after 5 June 2016)**

Electroplating

- Alloy Plating
- Copper Plating
- Gold Plating
- Nickel Plating
- Silver Plating
- Tin Plating

**AC7108/10 - Nadcap Audit Criteria for Electroless Plating (to be used on audits on/after 5 June 2016)**

Nickel

**AC7108/12 - Nadcap Audit Criteria for Acid Cleaning, Descaling, Passivation and Electropolishing (to be used on audits on/after 5 June 2016)**

Passivation

**AC7108/13 - Nadcap Audit Criteria for Brush Anodizing and Plating (to be used on audits on/after 5 June 2016)**

Brush Plating